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DÉCLARATION

DECLARATION

Je, soussigné (nom du témoin de la 1ère page),

dont l'adresse postale complète est:

I, the undersigned (name of the witness of the 1st page)

Nathalie Harput, whose full post office address is:

3000 Alton Goldbloom Apt 415, Laval, Québec, Canada

H7V 3R5.

déclare: j'ai été personnellement présent et ai vu le  
représentant de **TRIOSYN ROYALTY  
CORPORATION** (anciennement nommé **TRIOSYN  
CORPORATION**) que je reconnais personnellement  
comme étant la personne nommée dans la cession ci-  
jointe, signer et souscrire ladite cession.

make oath and say: that I was personally present and did  
see a representative of **TRIOSYN ROYALTY  
CORPORATION** (herein before known as **TRIOSYN  
CORPORATION**) who is personally known to me to  
be the person named in the attached assignment duly sign  
and execute the same.

SIGNÉ À (ville), \_\_\_\_\_, (province)  
\_\_\_\_\_, (pays)  
ce \_\_\_\_\_ ième jour de \_\_\_\_\_ 2001.

SIGNED AT Mirabel, Québec, Canada, this 20th day of  
July 2001.

Witness

(same person as on the assignment)

Témoin  
(même personne qui a signé la cession)

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**"ANNEX A"**

Re: transfer from TRIOSYN CORPORATION to TRIOSYN HOLDING INC. of  
Iodine/Resin patents, patent applications, etc.

**CANADA:**

- Canadian patent no. 2140639

**UNITED STATES OF AMERICA:**

- United States patent no. 5639452
- United States patent no. 5980827
- United States patent no. 6045820
- United States patent application no. 09/267056
- United States patent application no. 09/465968
- United States patent application no. 09/735,125

**EUROPE (REGION):**

- European Patent no. 0660668 including without limitation the following validated countries:

- United Kingdom
- France
- Germany
- Belgium
- Denmark
- Spain
- Ireland
- Italy
- Liechtenstein
- Luxembourg
- Monaco
- Netherlands
- Sweden
- Switzerland

- European Patent application no. 97108792.9
- European Patent application no. 97109103.8

**JAPAN:**

- Japanese patent application no. 06-507628

**NEW ZEALAND:**

- New Zealand patent no. 255299
- New Zealand patent no. 299530
- New Zealand patent no. 299531
- New Zealand patent no. 299532

**AUSTRALIA:**

- Australian patent no. 688276
- Australian patent no. 719312
- Australian patent no. 719355
- Australian patent application no. 48770/00

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*Handwritten signatures and initials*